

1A Lithium Ion Battery Linear Charger ME4057 Series

General Description

ME4057 is a complete constant-current/constant voltage linear charger for single cell lithium-ion batteries. With a thermally enhanced 8-PIN SOP package on the bottom and low external component count make the ME4057 ideally suited for portable applications. Furthermore the ME4057 is specifically designed to work within USB power specifications.

No external sense resistor is needed and no blocking diode is required due to the internal PMOSFET architecture .Thermal feedback regulates the charge current to limit the die temperature during high power operation or high ambient temperature .The charge voltage is fixed at 4.2V / 4.34V, and the charge current can be programmed externally with a single resistor. The ME4057 automatically terminates the charge cycle when the charge current drops to 1/10th the programmed value after the final float voltage is reached.

When the input supply (wall adapter or USB supply) is removed the ME4057 automatically enters a low current state dropping the battery drain current to less than 2µA.The ME4057 can be put into shutdown mode reducing the supply current to 55µA.

Other features include Battery temperature monitor, under-voltage lockout, automatic recharge and two status pins to indicate charge and charge termination.

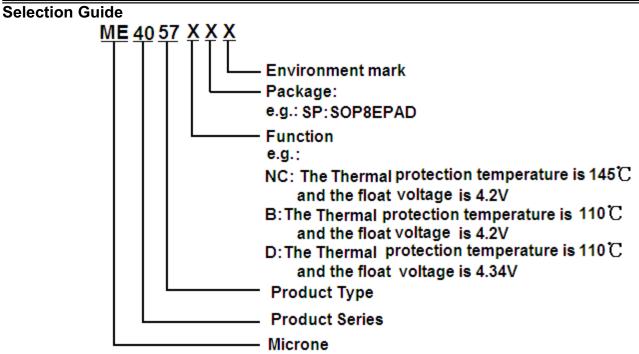
Features

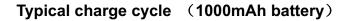
- Protection of battery cell reverse connection
- Programmable charge current up to 1A
- •No MOSFET sense resistor or blocking diode required
- •Complete linear Charger in SOP8 Package for single Cell Lithium-Ion Batteries.
- Constant-Current/Constant-Voltage operation with thermal regulation to maximize Rate Without risk of overheating.
- Preset 4.2V / 4.34V charge voltage with ±1% accuracy
- Automatic Recharge
- Two Status Indication for Charge status, no battery and battery failure indicators
- C/10 charge termination
- 55µA supply current in shutdown
- 2.9V trickle current charge threshold
- Soft-Start limits inrush current
- Battery Temperature Sensing

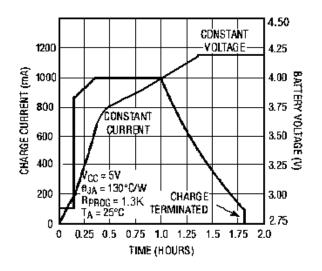
Applications

- Cellular Telephones
- Digital Still Cameras
- •MP3 Players
- •Bluetooth Applications
- Portable Devices
- •USB Bus-Powered Chargers

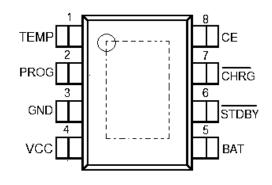








Pin Configuration



Package type: SOP8-PP



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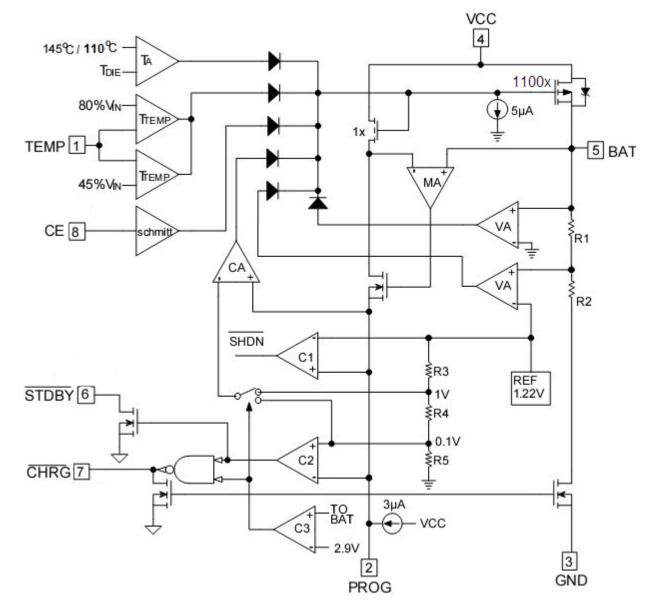
ME4057 Series

Pin Assignment

Pin Num.	Symbol	Function			
1	ТЕМР	Temperature sense input Connecting TEMP pin to NTC thermistor's output in Lithium ion battery pack. If TEMP pin's voltage is below 45% or above 80% of supply voltage V_{CC} , this means that battery's temperature is too low or too high, charging is suspended. The temperature sense function can be disabled by grounding the TEMP pin.			
2	PROG	Constant Charge Current Setting and Charge Current Monitor Pin The charge current is programmed by connecting a resistor R _{PROG} from this pin to GND. When in precharge mode, the PROG pin's voltage is regulated to 0.1V. When charging in constant-current mode this pin's voltage is regulated to 1V. In all modes during charging, the voltage on this pin can be used to measure the charge current using the following formula: $I_{BAT} = \frac{V_{PROG}}{R_{PROG}} * 1100$			
3	GND	Ground			
4	V _{cc}	Positive input supply voltage Provides power to the internal circuit. When V _{CC} drops to within 80mV of the BAT pin voltage, the ME4057 enters low power sleep mode, dropping I _{BAT} to less than 2µA.			
5	BAT	Battery connection Pin Connect the positive terminal of the battery to this pin. Dropping BAT pin's current to less than 2µA when IC in disable mode or in sleep mode. BAT pin provides charge current to the battery and provides regulation voltage of 4.2V /4.34V.			
6	STDBY	Charge terminated status output STDBY is pulled low by an internal switch to indicate a battery charge terminated; this means Charge termination. Otherwise STDBY pin is in high impedance state.			
7	CHRG	Open-Drain charge status output When the battery is being charged, the CHRG pin is pulled low by an internal switch, otherwise, CHRG pin is in high impedance state.			
8	CE	Chip enable input A high input will put the device in the normal operating mode. Pulling the CE pin to low level will put the ME4057 into disable mode. The CE pin can be driven by TTL or CMOS logic level.			



Block Diagram





Absolute Maximum Ratings

Parameter	Rating	Unit
Input supply voltage : V _{CC}	-0.3~6.5	V
PROG pin voltage	-0.3~VCC+0.3	V
BAT pin voltage	-0.3~6.5	V
TEMP pin voltage	-0.3~6.5	V
STDBY pin voltage	-0.3~6.5	V
CHRG pin voltage	-0.3~6.5	V
CE pin voltage	-0.3~6.5	V
BAT pin current	1200	mA
PROG pin current	1200	μA
Maximum junction temperature	145	°C
Operating ambient temperature :T _{opa}	-40~85	°C
Storage temperature :T _{str}	-65~125	°C
Soldering temperature and time	+260 (Recommended 10S)	°C

Caution: The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.



Electrical Characteristics

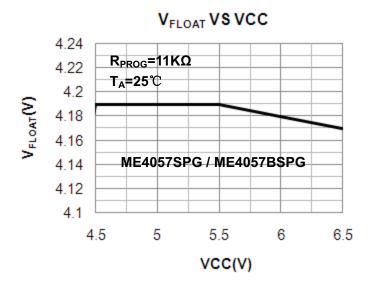
Symbol	Parameter	Condition		Min	Тур.	Max	Unit	
V _{cc}	Input supply voltage	•		4.0	5.0	6.5	V	
		●Charge mode, R _{PROG} =1.1KΩ		-	150	500	μA	
I _{CC} -I _{BAT}	static current	 Standby mode(charge end) 		-	55	100	μA	
ICC -IBAI		•Shutdown mode (R_{PROG} not connected, V_{CC} < V_{BAT} , or V_{CC} < V_{UV})			-	55	100	μA
V _{FLOAL}	Regulated output voltage	0℃≤T _A ≤85℃ ME4057BSPG ME4057DSPG		4.158	4.2	4.242	v	
				ME4057DSPG	4.3	4.34	4.38	
		• R_{PROG} =2.2K Ω , current mode			450	500	550	mA
		●R _{PROG} =1.			950	1000	1050	mA
I _{BAT}	BAT pin current (The condition of current mode is V_{BAT} =3.9V)	 Standby mode: 			0	-2.5	-6	μA
		Shutdown	mode, R _P	ROG not connected	-	±1	±2	μA
		Sleep mod	e, V _{CC} =0	V	-	-1	-2	μA
I _{TRIKL}	Trickle charge current	•V _{BAT} <v<sub>TRIKL, R_{PROG}=1.1KΩ</v<sub>		120	130	140	mA	
V _{TRIKL}	Trickle charge threshold voltage	R_{PROG} =1.1K Ω , V_{BAT} rising		2.8	2.9	3.0	V	
V _{TRHYS}	Trickle voltage hysteresis voltage	R _{PROG} =1.1KΩ		350	400	450	m۱	
V _{UV}	V _{CC} under voltage lockout threshold	• V _{CC} from low to high		3.5	3.7	3.9	V	
V _{UVHYS}	V _{CC} under voltage lockout hysteresis	•		150	200	300	m۱	
	V _{CC} -V _{BAT} lockout threshold voltage	V _{CC} from low to high			100	140	180	mV
▼ ASD		V _{CC} from high to low		50	80	110		
	C/10 termination current	•R _{PROG} =2.2KΩ		60	70	80	mA	
TERM	threshold	•R _{PROG} =1.1KΩ		120	130	140		
V _{PROG}	PROG pin voltage	• R_{PROG} =1.1K Ω ,current mode		0.9	1.0	1.1	V	
V _{CHRG}	CHRG Pin output low voltage	I _{CHRG} =5mA		-	0.3	0.6	v	
V _{STDBY}	STDBY Pin output low voltage	ISTDBY =5mA		-	0.3	0.6	V	
V _{TEMP-H}	The voltage at TEMP increase			-	80	83	%Vo	
V _{TEMP-L}	The voltage at TEMP decrease			42	45	-	%Va	
ΔV_{RECHRG}	Recharge battery threshold voltage	V _{FLOAT} -V _{RECHRG}		120	180	240	m∖	
T _{LIM}	Thermal protection	ME4057SPG		-	145	-	°C	
	temperature	ME4057BSPG/ ME4057DSPG		-	110	-		
R _{ON}	The resistance of power FET "ON"(between V _{CC} and BAT)	;			-	650	-	mΩ

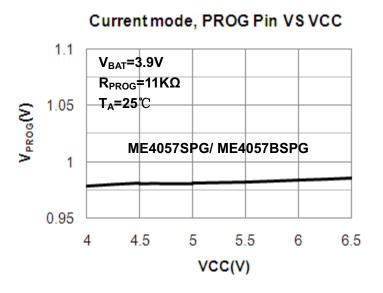


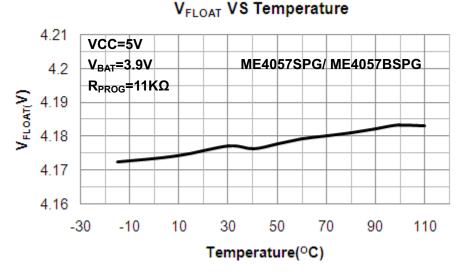
t _{ss}	Soft-start time	I _{BAT} =0 to I _{BAT} =1100V/R _{PROG}	-	20	-	μS
t _{recharge}	Recharge comparator filter time	V _{BAT} from high to low	0.8	1.8	4	mS
t _{TERM}	Termination comparator filter time	I _{BAT} below I _{CHG} /10	0.8	1.8	4	mS
I _{PROG}	PROG pin pull-up current		-	2.0	-	μA
t _{ss}	Soft-start time	I _{BAT} =0 to I _{BAT} =1100V/R _{PROG}	-	20	-	μS
t _{RECHARGE}	Recharge comparator filter time	V _{BAT} from high to low	0.8	1.8	4	mS
t _{TERM}	Termination comparator filter time	I _{BAT} below I _{CHG} /10	0.8	1.8	4	mS
I _{PROG}	PROG pin pull-up current		-	2.0	-	μA

Note: The \bullet denotes specifications which apply over the full operating temperature rang, otherwise specifications are at T_A=25°C, V_{CC}=5V, unless otherwise specified.

Typical performance characteristics







PROG Pin Voltage VS Temperature 1.1 1 0.9 V_{PROG}(V) VCC=5V 0.8 $R_{PROG}=11K\Omega$ 0.7 0.6 0.5 -20 0 20 40 60 80 100 Temperature(°C)

Description of the Principle

The ME4057 is a complete constant-current/constant-voltage linear charger for single cell lithium-ion batteries. Constant-current/constant-voltage to charger batter by internal MOSFET .It can deliver up to 1A of charge current .No blocking diode or external current sense resistor is required. ME4057 include two Open-Drain charge status Pins: Charge status indicator CHRG and battery failure status output STDBY.

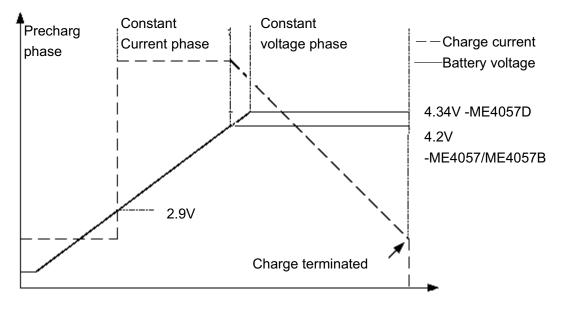
The internal thermal regulation circuit reduces the programmed charge current if the die temperature attempts to rise above a preset value of approximately 145° or 110° (ME4057B / ME4057D). This feature protects the ME4057 from excessive temperature, and allows the user to push the limits of the power handling capability of a given circuit board without risk of damaging the ME4057 or the external components. Another benefit of adopting thermal regulation is that charge current can be set according to typical, not worst-case, ambient temperatures for a given application with the assurance that the charger will automatically reduce the current in worst-case conditions.

The charge cycle begins when the voltage at the V_{CC} pin rises above the UVLO level, a current set resistor is connected from the PROG pin to ground, and the CE pin is pulled above the chip enable threshold. The CHRG pin



outputs a logic low to indicate that the charge cycle is on going. At the beginning of the charge cycle, if the battery voltage is below 2.9V, the charge is in precharge mode to bring the cell voltage up to a safe level for charging. The charger goes into the fast charge constant-current mode once the voltage on the BAT pin rises above 2.9 V. In constant current mode, the charge current is set by R_{PROG} . When the battery approaches the regulation voltage 4.2V /4.34V, the charge current begins to decrease as the ME4057 enters the constant-voltage mode. When the current drops to charge termination threshold, the charge cycle is terminated, and \overline{CHRG} pin assumes a high impedance state to indicate that the charge cycle is terminated and \overline{STDBY} pin is pulled low. The charge termination threshold is 10% of the current in constant current mode. To restart the charge cycle, remove the input voltage and reapply it, or momentarily force CE pin to 0V. The charge cycle can also be automatically restarted if the BAT pin voltage falls below the recharge threshold. The on-chip reference voltage, error amplifier and the resistor divider provide regulation voltage with 1% accuracy which can meet the requirement of lithium-ion and lithium polymer batteries. When the input voltage is not present, or input voltage is below V_{BAT}, the charger goes into a sleep mode, dropping battery drain current to less than 3µA. This greatly reduces the current drain on the battery and increases the standby time. The charger can be shutdown by forcing the CE pin to GND.

The charging profile is shown in the following figure:



Programming charge current

The charge current is programmed using a single resistor from the PROG pin to ground. The program resistor and the charge current are calculated using the following equations.:

$$\mathsf{R}_{\mathsf{PROG}} = \frac{1100}{\mathsf{I}_{\mathsf{BAT}}} (\mathsf{error} \pm 10\%)$$



Charge termination

A charge cycle is terminated when the charge current falls to $1/10^{th}$ the programmed value after the final float voltage is reached. This condition is detected by using an internal filtered comparator to monitor the PROG pin. When the PROG pin voltage falls below 100mV for longer than t_{TEMP} (typically 1.8mS), Charging is terminated. The charge current is latched off and the ME4057 enters standby mode, where the input supply current drops to 55µA (Note:C/10 termination is disabled in trickle charging and thermal limiting modes).

When charging, transient loads on the BAT pin can cause the PROG pin to fall below 100mV for short periods of time before the DC charge current has dropped to $1/10^{th}$ the programmed value. The 1.8mS filter time (t_{TEMP}) on the termination comparator ensures that transient loads of this nature do not result in premature charge cycle termination. Once the average charge current drops below $1/10^{th}$ the programmed value, the ME4057 terminated the charge cycle and ceases to provide any current through the BAT pin. In this state all loads on the BAT pin must be supplied by the battery.

The ME4057 constantly monitors the BAT pin voltage in standby mode. If this voltage drops below the 4.02V(ME4057D is 4.16V) recharge threshold (V_{RECHRG}), another charge cycle begins and current is once again supplied to the battery. To manually restart a charge cycle when in standby mode, the input voltage must be removed and reapplied or the charger must be shut down and restarted using the PROG pin. Figure 1 shows the state diagram of a typical charge cycle.

Charge status indicator

ME4057 has two open-drain status indicator output CHRG and STDBY.CHRG is pull-down when the ME4057 in a charge cycle. In other status CHRG in high impedance. CHRG and STDBY are all in high impedance when the battery out of the normal temperature.

Represent in failure state, when TEMP pin in typical connecting, or the charger with no battery: red LED and green LED all don't light. The battery temperature sense function is disabled by connecting TEMP pin to GND. If battery is not connected to charger, \overrightarrow{CHRG} pin outputs a PWM level to indicate no battery. If BAT pin connects a 10µF capacitor, the frequency of \overrightarrow{CHRG} flicker about 1-4S, If not use status indicator should set status indicator output connected to GND.

charger's status	Red led CHRG	Green led STDBY	
Charging	light	dark	
Battery in full state	dark	light	
Under-voltage, battery's temperature is to high or too low, or not	dark	dark	
connect to battery(use TEMP)			
	Green LED bright, Red LED flicker F=1-4 S		
DAT min is composited to 10.15 compositer. No bottom, mode	(At this time, reverse-battery, the light does		
BAT pin is connected to 10μ F capacitor, No battery mode	not shine, this phenomenon is normal. Such a		
(TEMP=GND)	case, after the battery is properly connected to		
	the indicator light back to light and flicker.)		



Thermal limiting

An internal thermal feedback loop reduces the programmed charge current if the die temperature attempts to rise above a preset value of approximately 140°C (ME4057B / ME4057D is approximately 105°C). The feature protects the ME4057 from excessive temperature and allows the user to push the limits of the power handling capability of a given circuit board without risk of damaging the ME4057. The charge current can be set according to typical (not worst-case) ambient temperature with the assurance that the charger will automatically reduce the current in worst-case conditions.

To prevent the damage caused by the very high or very low temperature done to the battery pack, the ME4057 continuously senses battery pack temperature by measuring the voltage at TEMP pin determined by the voltage divider circuit and the battery's internal NTC thermistor as shown in Figure 1.

The ME4057 compares the voltage at TEMP pin (VTEMP) against its internal VLow and VHIGH thresholds to determine if charging is allowed. In ME4057, VLow is fixed at (45%×Vcc), while VHIGH is fixed at (80%×Vcc). If VTEMP<VLOW or VTEMP>VHIGH, it indicates that the battery temperature is too high or too low and the charge cycle is suspended. When VTEMP is between VLow and VHIGH, charge cycle resumes. The battery temperature sense function can be disabled by connecting TEMP pin to GND.

Selecting R1 and R2

The values of R1 and R2 in the application circuit can be determined according to the assumed temperature monitor range and thermistor's values. The Follows is an example: Assume temperature monitor range is $T_L \sim T_H$, ($T_L < T_H$); the thermistor in battery has negative temperature coefficient (NTC, R_{TL} is thermistor's resistance at T_L , R_{TH} is the resistance at T_H , so $R_{TL} > R_{TH}$, then at temperature T_L , the voltage at TEMP pin is:

$$V_{\text{TEMPH}} = \frac{R2 \|R_{\text{TH}}}{R1 + R2 \|R_{\text{TH}}} \times VIN$$

At temperature TH, the voltage at TEMP pin is: $V_{\text{TEMPL}} = \frac{R2 ||R_{\text{TL}}}{R1 + R2 ||R_{\text{TL}}} \times VIN$

We know V_{TEMPL}=V_{HIGH}=K2×Vcc (K2=0.8); V_{TEMPH}=V_{LOW}=K1×Vcc (K1=0.45) Then we can have:

$$R1 = \frac{R_{TL}R_{TH}(K_2 - K_1)}{(R_{TL} - R_{TH})K_1K_2} \qquad R2 = \frac{R_{TL}R_{TH}(K_2 - K_1)}{R_{TL}(K_1 - K_1K_2) - R_{TH}(K_2 - K_1K_2)}$$

For example, NCP03YS110, operating Temperature is -40°C to 125°C. If using environment temperature is -25°C to 125°C, then R_{TL} is the value of the resistance of NCP03YS110 at -25°C, about 66.148 Ω ; R_{TH} =is the value of the resistance of NCP03YS110 at 125°C, about 1.077 Ω .

Likewise, for positive temperature coefficient thermistor in battery, we have $R_{TH} > R_{TL}$ and we can calculate:

$$R1 = \frac{R_{TL}R_{TH}(K2-K1)}{(R_{TH}-R_{TL})K1K2} \qquad R2 = \frac{R_{TL}R_{TH}(K2-K1)}{R_{TH}(K1-K1K2)-R_{TL}(K2-K1K2)}$$

We can conclude that temperature monitor range is independent of power supply voltage V_{CC} and it only depends on R1, R2, R_{TL} and R_{TH}: The values of R_{TH} and R_{TL} can be found in related battery handbook or deduced from testing data. In actual application, if only one terminal temperature is concerned (normally protecting overheating), there is no need to use R2 but R1. It becomes very simple to calculate R1 in this case.



Under Voltage lockout (UVLO)

An internal under voltage lockout circuit monitors the input voltage and keeps the charger in shutdown mode until V_{CC} rises above the under voltage lockout threshold. If the UVLO comparator is tripped, the charger will not come out of shutdown mode until V_{CC} rises 140mV above the battery voltage.

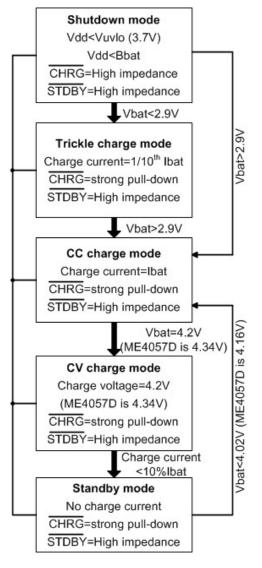
Manual terminate

At any time of the cycle of charging will put the ME4057 into disable mode to pull CE pin to GND, or remove R_{PROG} (PROG pin is float). This made the battery drain current to less than 2µA and reducing the supply current to 55µA. To restart the charge cycle, set CE pin in high level or connect a programming resistor.

If ME4057 in the under voltage Lockout mode, the \overline{CHRG} and \overline{STDBY} are all in high impedance state, or V_{CC} is above BAT pin 140mV, or V_{CC} is too low.

Auto restart

Once charge is been terminated, ME4057 immediately use a 1.8ms filter time ($t_{RECHARGE}$) on the termination comparator to constant monitor the voltage on BAT pin. If this voltage drops below the 4.02V recharge threshold (about between 80% and 90% of V_{CC}), another charge cycle begins. This ensured the battery maintained (or approach) to a charge full status and avoid the requirement of restarting the periodic charging cycle. In the recharge cycle, CHRG pin enters a pulled down status.



PROG

10**k**

Fig.1 State diagram of a typical charge cycle

Fig.2 Isolating with capacitive load on PROG Pin

Charge



Stability Considerations

In constant-current mode, the PROG pin is in the feedback loop, not the battery. The constant-current mode stability is affected by the impedance at the PROG pin. With no additional capacitance on the PROG pin, the charger is stable with program resistor values as high as $20K\Omega$. However, additional capacitance on this node reduces the maximum allowed program resistor. Therefore, if I_{PROG} pin is loaded with a capacitance C, the following equation should be used to calculate the maximum resistance value for R_{PROG} :

$$R_{PROG} \le \frac{1}{2\pi \bullet 10^5 \bullet C_{PROG}}$$

As user, may think charge current is important, not instantaneous current. For example, to run a low current mode switch power which parallel connected with battery, the average current from BAT pin usually importance to instantaneous current. In this case, In order to measure average charge current or isolate capacitive load from I_{PROG} pin, a simple RC filter can be used on PROG pin as shown in Figure 2. In order to ensure the stability add a 10K Ω resistor between PROG pin and filter capacitor.

Power dissipation

The conditions that cause the ME4057 to reduce charge current through thermal feedback can be approximated by considering the power dissipated in the IC. Nearly all of this power dissipation is generated by the internal MOSFET-this is calculated to be approximately: $P_D = (V_{CC} - V_{BAT}) \times I_{BAT}$

The following formulas all based on the IC of ME4057 (The 145° C in the following formulas should change to 110° C if used in ME4057B /ME4057D)

The approximate ambient temperature at which the thermal feedback begins to protect the IC is:

 $T_A = 145^\circ\mathrm{C} - P_D\theta_{\mathrm{JA}}\,; \qquad T_A = 145^\circ\mathrm{C} - \left(V_{CC} - V_{BAT}\,\right)\,X\,\,I_{BAT}\,X\,\,\,\theta_{\mathrm{JA}}$

For example: The ME4057 with 5V supply voltage through programmable provides full limiting current 800mA to a charge lithium-ion battery with 3.75V voltage. If θ_{JA} is 150°C/W (reference to PCB layout considerations), When ME4057 begins to decrease the charge current, the ambient temperature about:

 $T_{A} = 145^{\rm o}{\rm C} - (5V{-}\ 3.75V$) X (800mA) $\chi 150^{\rm o}{\rm C}$ / W

 $T_{A} = 145^{\circ}{\rm C} - 0.5W \ X \ 150^{\circ}{\rm C} \ / \ W = 145^{\circ}{\rm C} - 75^{\circ}{\rm C} \qquad T_{A} = 65^{\circ}{\rm C}$

ME4057 can work in the condition of the temperature is above 65° C, but the charge current will pull down to below 800mA. In a fixed ambient temperature, the charge current is calculated to be approximately :

$$I_{BAT} = \frac{145^{\circ}C - T_{A}}{(V_{CC} - V_{BAT}) \bullet \theta_{JA}}$$

Just as Description of the Principle part talks about so, the current on PROG pin will reduce in proportion to the reduced charge current through thermal feedback. In ME4057 design applications don't need to considerate the worst case of thermal condition, this point is importance, because if the junction temperature up to 145° (ME4057B / ME4057D is 110°),IC will auto reduce the power dissipation.

Thermal considerations

Because of the small size of the thin SOP8 package, it is important to use a good thermal PC board layout to maximize the available charge current. The thermal path for the heat generated by the IC is from the die to the copper lead frame, through the package leads, (especially the ground lead) to the PC board copper. The PC board copper is the heat sink. The footprint copper pads should be as wide as possible and expand out to larger copper areas to spread and dissipate the heat to the surrounding ambient. Other heat sources on the board, not related to the charger, must also be considered when designing a PC board layout because they will affect overall temperature rise and the maximum charge current.



Add thermal regulation current

It will effective to decrease the power dissipation through reduce the voltage of both ends of the inner MOSFET. In the thermal regulation, this action of transporting current to battery will raise. One of the measure is through an external component(as a resistor or diode) to consume some power dissipation.

For example: The ME4057 with 5V supply voltage through programmable provides full limiting current 800mA to a charge lithium-ion battery with 3.75V voltage. If θ_{JA} is 125°C/W, so that at 25°C ambient temperature, the charge current is calculated to be approximately : $|_{BAT} = \frac{145^{\circ}C - 25^{\circ}C}{145^{\circ}C - 25^{\circ}C}$

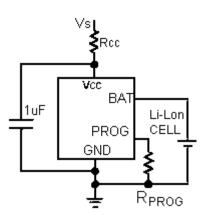
$$(V_{\rm S} - I_{\rm BAT} {\rm Rcc} - V_{\rm BAT}) \bullet \theta_{\rm JA}$$

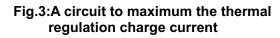
In order to increase the thermal regulation charge current, can decrease the power dissipation of the IC through reducing the voltage (as show fig.3) of both two ends of the resistor which connecting in series with a 5V AC adapter. With square equation to calculate I_{BAT} :

$$I_{BAT} = \frac{(V_{S} - V_{BAT}) - \sqrt{(V_{S} - V_{BAT})^{2} - \frac{4R_{CC}(145^{\circ}C - T_{A})}{\theta_{JA}}}}{2R_{CC}}$$

If $R_{CC}=0.25\Omega$, $V_{S}=5V$, $V_{BAT}=3.75V$, $T_{A}=25^{\circ}C$ and $\theta_{JA} = 125^{\circ}C/W$, we can calculate the thermal regulation charge current: $I_{BAT}=948$ mA. It means that in this structure it can output 800mA full limiting charge current at more high ambient temperature environment.

Although it can transport more energy and reduce the charge time in this application, but actually spread charge time, if ME4057 stay in under-voltage state, when V_{CC} becomes too low in voltage mode. Fig.4 shows how the voltage reduced with increase R_{CC} value in this circuit. This technique will act the best function when in order to maintain the minimize the dimension of the components and avoid voltage decreased to minimize R_{CC} .





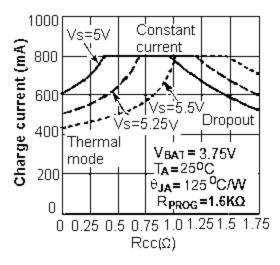


Fig.4:The relationship curve between charge current with R_{cc}

V_{CC} bypass capacitor

Many types of capacitors can be used for input bypassing, however, caution must be exercised when using multilayer ceramic capacitors. Because of the self-resonant and high Q characteristics of some types of ceramic capacitors, high voltage transients can be generated under some start-up conditions, such as connecting the charger input to a live power source. Adding a 1.5Ω resistor in series with a ceramic capacitor will minimize start-up voltage transients.



Charging Current Soft Start

ME4057 includes a soft start circuit which used to maximize to reduce the surge current in the begging of charge cycle. When restart a new charge cycle, the charging current ramps up from 0 to the full charging current within 20µs. In the start process it can maximize to reduce the action which caused by surge current load.

USB and Wall Adapter Power

ME4057 allows charging from a USB port, a wall adapter can also be used to charge Li-Ion/Li-polymer batteries. Figure 5 shows an example of how to combine wall adapter and USB power inputs. A P-channel MOSFET, M1, is used to prevent back conducting into the USB port when a wall adapter is present and Schottky diode, D1, is used to prevent USB power loss through the 1K Ω pull-down resistor.

Generally, AC adaptor is able to provide bigger much current than the value of specific current limiting which is 500mA for USB port. So can rise charge current to 600mA with using a N-MOSFET (MN1) and an additional set resistor value as high as $10K\Omega$.

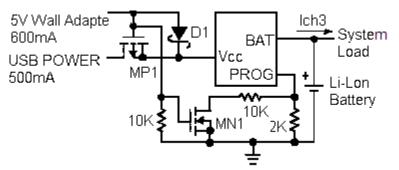


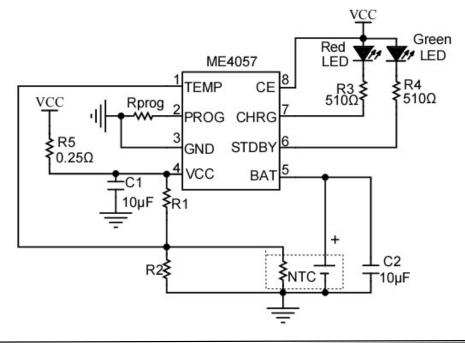
Fig.5:Combining Wall Adapter and USB Power

Typical Application

Mainly used in Cellular telephones, MP3, MP4 players, digital still cameras, electronic dictionary, GPS, portable

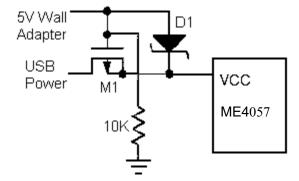
devices and vary chargers.

1. Suitable for the function of battery's temperature detection, the application of the indicator of battery's temperature anomaly and charge status.



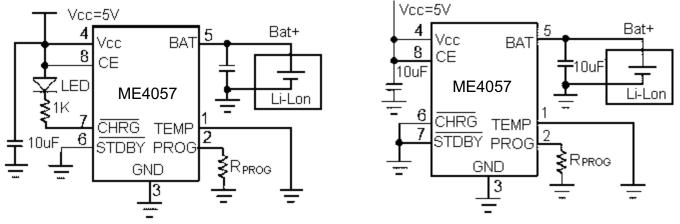


2. Suitable for the application of USB power and the charge of wall adapter

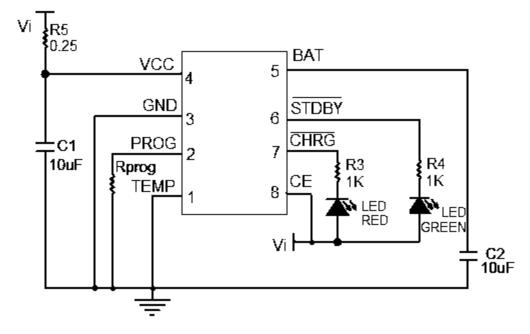


3. Suitable for charge status indicator, which the application not need battery's temperature detection.

4. Suitable for the application which not need charge status indicator and battery's temperature detection.



5. Add a resistor for power dissipation, Red LED for charge status, green LED for charge terminate state





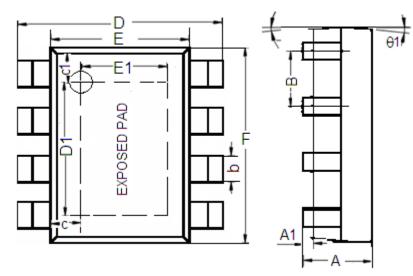
Board Layout Considerations

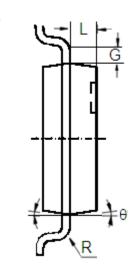
- R_{PROG} at PROG pin should be as close to ME4057 as possible, also the parasitic capacitance at PROG pin should be kept as small as possible.
- •The capacitance at V_{CC} pin and BAT pin should be as close to ME4057 as possible.
- During charging, ME4057's temperature may be high, the NTC thermistor should be placed far enough to ME4057 so that the thermistor can reflect the battery's temperature correctly.
- It is very important to use a good thermal PC board layout to maximize charging current. The thermal path for the heat generated by the IC is from the die to the copper lead frame through the package lead (especially the ground lead) to the PC board copper, the PC board copper is the heat sink. The footprint copper pads should be as wide as possible and expand out to larger copper areas to spread and dissipate the heat to the surrounding ambient. Feed through vias to inner or backside copper layers are also useful in improving the overall thermal performance of the charger. Other heat sources on the board, not related to the charger, must also be considered when designing a PC board layout because they will affect overall temperature rise and the maximum charge current.
- •The ability to deliver maximum charge current under all conditions require that the exposed metal pad on the back side of the ME4057 package be soldered to the PC board ground. Failure to make the thermal contact between the exposed pad on the backside of the package and the copper board will result in larger thermal resistance.



Packaging Information:

Packaging Type: SOP8-PP





Character	Dimensio	on (mm)	Dimension (Inches)		
	Min	Мах	Min	Max	
А	1.350	1.750	0.053	0.069	
A1	0.1	0.3	0.004	0.012	
В	1.27(Typ.)		0.05(Гур.)	
b	0.330	0.510	0.013	0.020	
С	0.9(1	yp.)	0.035(Typ.)		
c1	1.0(Тур.)		0.039(Typ.)		
D	5.8	6.2	0.228	0.244	
D1	3.202	3.402	0.126	0.134	
E	3.800	4.000	0.150	0.157	
E1	2.313	2.513	0.091	0.099	
F	4.7	5.1	0.185	0.201	
L	0.675	0.725	0.027	0.029	
G	0.32(Typ.)		0.013(Typ.)		
R	0.15(Тур.)		0.006(Typ.)		
θ1	7°		7°		
θ	8	0	8	<u>, </u>	



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